Electronic Patent Application Fee Transmittal							
Application Number:	10520444						
Filing Date:	06-Jan-2005						
Title of Invention:	HYGROSCOPIC MOLDING						
First Named Inventor/Applicant Name:	Teruo Uchibori						
Filer:	Raymond D. Smith/MARY NGUYEN						
Attorney Docket Number:	SAEG103.003APC						
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Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
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